Features:

- R Value extension of RMCF product, values up to 10G
- E24 values
- RoHS compliant, REACH compliant, and halogen free



Electrical Specifications								
Type/Code	Power Rating	Maximum Working	Maximum Overload	TCR (ppm/°C)	Ohmic Range (Ω) and Tolerance			
	(W) @ 70°C	Voltage (V) (1)	Voltage (V)		1%	5%	10%	
HMC0402	0.063	50	100	± 200	11M - 20M	-		
1 IIVIC0402	0.003	30	100	± 400		22M - 100M		
				± 200	11M - 20M	-		
HMC0603	0.1	50	100	± 400		22M - 100M		
				± 500	•	110M	1 - 1G	
	0.125	150	300	± 200	11M - 20M	-		
				± 400		22M - 100M		
HMC0805				± 500	-	110M - 500M		
				± 1000	-	510M - 1G		
				± 1500	-	1.2G - 10G		
	0.25	200	400	± 200	11M - 20M	-		
				± 400	22M - 100M	30M - 100M		
HMC1206				± 500	-	110M	- 500M	
				± 1000	-	510M	1 - 1G	
				± 1500	-	1.2G	- 10G	
HMC1210	0.33	200	400	± 200	11M - 20M	-	11M - 20M	
HIVIC 12 10				± 400		22M - 100M		
HMC2010	0.75	200	400	± 200		11M - 20M		
HIVIC2010	0.75			± 400	22M - 100M			
HMC2512	1	250	500	± 200	11M - 20M			
TIMOZSTZ	ı			± 400		22M - 100M		

(1) Lesser of $\sqrt{(P^*R)}$ or maximum working voltage.

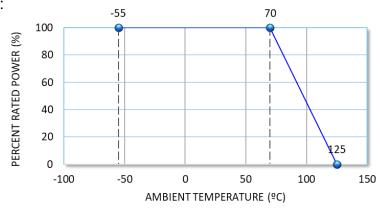
Type/Code	L Body Longth	W Body Width	H Body Height	a Ton Tormination	b Bottom Termination	Unit
	Body Length	Body Width	Body Height	Top Termination	Bottom Termination	
HMC0402	0.039 ± 0.002	0.020 ± 0.002	0.014 ± 0.002	0.008 ± 0.004	0.008 ± 0.004	inches
	1.00 ± 0.05	0.50 ± 0.05	0.35 ± 0.05	0.20 ± 0.10	0.20 ± 0.10	mm
HMC0603	0.063 ± 0.004	0.031 ± 0.004	0.018 ± 0.004	0.012 ± 0.008	0.012 ± 0.008	inches
	1.60 ± 0.10	0.80 ± 0.10	0.45 ± 0.10	0.30 ± 0.20	0.30 ± 0.20	mm

Mechanical Specifications									
Type/Code	L Body Length	W Body Width	H Body Height	a Top Termination	b Bottom Termination	Unit			
HMC0805	0.079 ± 0.008	0.049 ± 0.004	0.020 ± 0.004	0.016 ± 0.008	0.016 ± 0.008	inches			
	2.00 ± 0.20	1.25 ± 0.10	0.50 ± 0.10	0.40 ± 0.20	0.40 ± 0.20	mm			
HMC1206	0.122 ± 0.006	0.061 ± 0.004	0.022 ± 0.006	0.020 ± 0.010	0.020 ± 0.008	inches			
	3.10 ± 0.15	1.55 ± 0.10	0.55 ± 0.15	0.50 ± 0.25	0.50 ± 0.20	mm			
HMC1210	0.126 ± 0.008	0.102 ± 0.006	0.022 ± 0.004	0.020 ± 0.008	0.020 ± 0.008	inches			
	3.20 ± 0.20	2.60 ± 0.15	0.55 ± 0.10	0.50 ± 0.20	0.50 ± 0.20	mm			
HMC2010	0.197 ± 0.008	0.098 ± 0.006	0.022 ± 0.004	0.024 ± 0.010	0.020 ± 0.008	inches			
	5.00 ± 0.20	2.50 ± 0.15	0.55 ± 0.10	0.60 ± 0.25	0.50 ± 0.20	mm			
HMC2512	0.250 ± 0.008	0.126 ± 0.006	0.022 ± 0.004	0.024 ± 0.010	0.020 ± 0.008	inches			
	6.35 ± 0.20	3.20 ± 0.15	0.55 ± 0.10	0.60 ± 0.25	0.50 ± 0.20	mm			

Performance Characteristics						
Test	Test Test Condition (JIS C 5202) Test Result					
Long Term Stability	Nominal temperature & humidity for 1000 hours	± 0.5%				
High Temperature Loading	15 VDC, 1.5 hour ON, 0.5 hour OFF, 1000 hours 70°C	± 3%				
Resistance to Solder Heat	260 ± 5°C, 10 seconds +1/-0	± 1%				
Short Time Overload	5 seconds at maximum overload voltage	± 2%				

Operating temperature range is -55 to +125°C

Power Derating Curve:



Recommended Pad Layout С Type/Code Α В Unit 0.020 0.018 0.024 inches HMC0402 0.50 0.45 0.60 mm0.035 0.024 0.035 inches HMC0603 0.90 0.60 0.90 mm 0.047 0.028 0.051 inches HMC0805 0.70 1.20 1.30 mm 0.079 0.035 0.063 inches HMC1206 2.00 0.90 1.60 mm 0.079 0.035 0.110 inches HMC1210 2.00 0.90 2.80 mm 0.035 0.110 0.150 inches HMC2010 3.80 0.90 2.80 mm 0.193 0.063 0.138 inches HMC2512 4.90 1.60 3.50 mm

Recommended Solder Profile

This information is intended as a reference for solder profiles for Stackpole resistive components. These profiles should be compatible with most soldering processes. These are only recommendations. Actual numbers will depend on board density, geometry, packages used, etc., especially those cells labeled with "*".

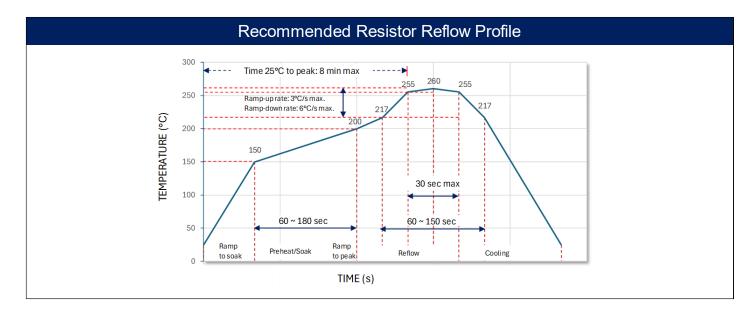
100% Matte Tin / RoHS Compliant Terminations

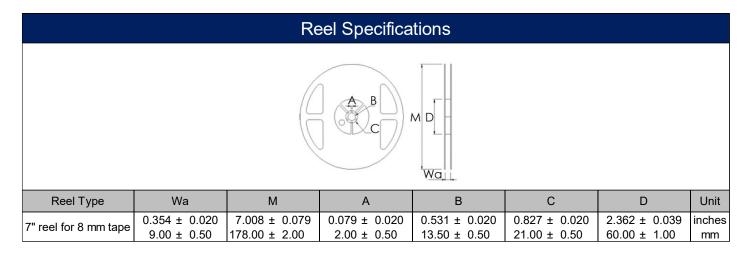
Soldering iron recommended temperatures: 330°C to 350°C with minimum duration. Maximum number of reflow cycles: 3.

Wave Soldering								
Description	Description Maximum Recommended Minimum							
Preheat Time 80 seconds		70 seconds	60 seconds					
Temperature Diff. 140°C		120°C	100°C					
Solder Temp.	260°C	250°C	240°C					
Dwell Time at Max	10 seconds	5 seconds	*					
Ramp DN (°C/sec)	N/A	N/A	N/A					

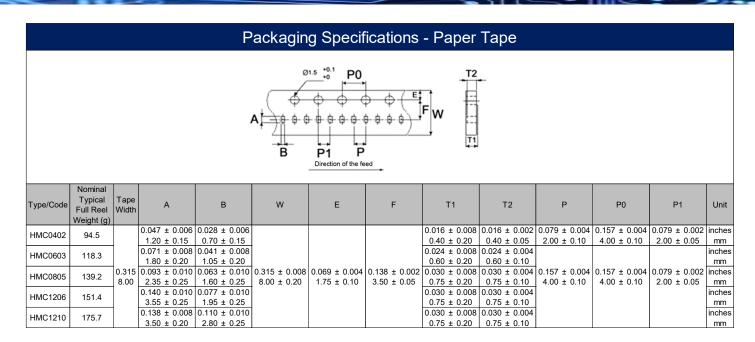
Temperature Diff. = Difference between final preheat stage and soldering stage.

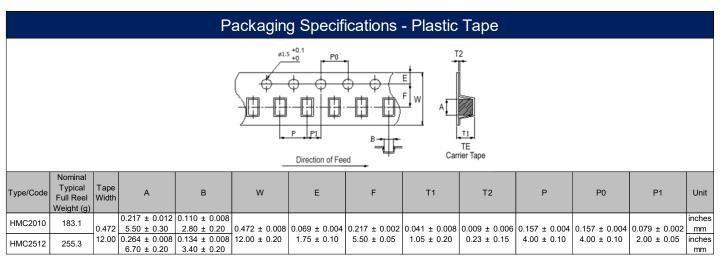
Convection IR Reflow							
Description	Description Maximum Recommended Minimum						
Ramp Up (°C/sec)	3°C/sec	2°C/sec	*				
Dwell Time > 217°C 150 seconds		90 seconds	60 seconds				
Solder Temp.	260°C	245°C	*				
Dwell Time at Max.	30 seconds	15 seconds	10 seconds				
Ramp DN (°C/sec)	6°C/sec	3°C/sec	*				





Rev Date: 5/8/2024





Part Marking Instructions E24 Values for 0603 - 2512 The nominal resistance is marked on the surface of the overcoating with the use of three character markings. 1. First and second digits are E24 code; third digit is the multiplier 2. 0402 size is unmarked 11 MΩ 470 MΩ

Stackpole Electronics, Inc.

Resistive Product Solutions

High Resistance Thick Film Chip Resistor

RoHS Compliance

Stackpole Electronics has joined the worldwide effort to reduce the amount of lead in electronic components and to meet the various regulatory requirements now prevalent, such as the European Union's directive regarding "Restrictions on Hazardous Substances" (RoHS 3). As part of this ongoing program, we periodically update this document with the status regarding the availability of our compliant components. All our standard part numbers are compliant to EU Directive 2011/65/EU of the European Parliament as amended by Directive (EU) 2015/863/EU as regards the list of restricted substances.

	RoHS Compliance Status								
Standard Product Series	Description	Package / Termination Type	Standard Series RoHS Compliant	Lead-Free Termination Composition	Lead-Free Mfg. Effective Date (Std Product Series)	Lead-Free Effective Date Code (YY/WW)			
НМС	High Resistance Thick Film Chip Resistor	SMD	YES(1)	100% Matte Sn over Ni	Jan-04	04/01			

Note (1): RoHS compliant by means of exemption 7c-I.

"Conflict Metals" Commitment

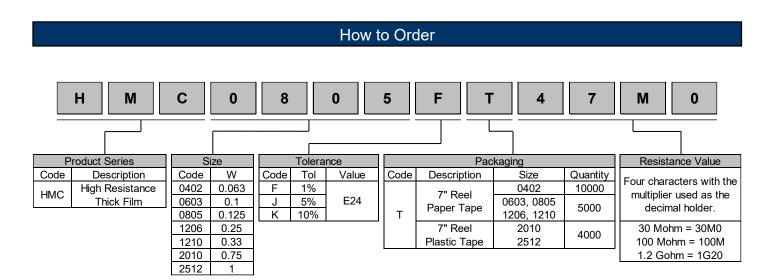
We at Stackpole Electronics, Inc. are joined with our industry in opposing the use of metals mined in the "conflict region" of the eastern Democratic Republic of the Congo (DRC) in our products. Recognizing that the supply chain for metals used in the electronics industry is very complex, we work closely with our own suppliers to verify to the extent possible that the materials and products we supply do not contain metals sourced from this conflict region. As such, we are in compliance with the requirements of Dodd-Frank Act regarding Conflict Minerals.

Compliance to "REACH"

We certify that all passive components supplied by Stackpole Electronics, Inc. are SVHC (Substances of Very High Concern) free and compliant with the requirements of EU Directive 1907/2006/EC, "The Registration, Evaluation, Authorization and Restriction of Chemicals", otherwise referred to as REACH. Contact us for complete list of REACH Substance Candidate List.

Environmental Policy

It is the policy of Stackpole Electronics, Inc. (SEI) to protect the environment in all localities in which we operate. We continually strive to improve our effect on the environment. We observe all applicable laws and regulations regarding the protection of our environment and all requests related to the environment to which we have agreed. We are committed to the prevention of all forms of pollution.



6